

Title (en)
LINKER COMPOUNDS COMPRISING AMIDE BONDS

Title (de)
LINKERVERBINDUNGEN MIT AMIDBINDUNGEN

Title (fr)
COMPOSÉS LIEURS COMPRENANT DES LIAISONS AMIDE

Publication
EP 4228671 A1 20230823 (EN)

Application
EP 21881131 A 20211014

Priority
• US 202063093062 P 20201016
• US 2021055085 W 20211014

Abstract (en)
[origin: WO2022081911A1] Various embodiments provide a homo-bivalent linker compound comprising identical functional groups at either end, methods of making such linker compounds, and methods of using the linker compounds.

IPC 8 full level
A61K 38/16 (2006.01); **C07K 1/22** (2006.01); **C07K 14/00** (2006.01)

CPC (source: EP IL KR US)
A61K 31/713 (2013.01 - KR); **A61K 47/55** (2017.07 - EP IL); **A61K 47/65** (2017.07 - EP IL KR US); **A61K 48/0033** (2013.01 - KR); **C07K 5/06026** (2013.01 - EP IL KR US); **C07K 5/06052** (2013.01 - EP IL KR US); **C07K 5/06086** (2013.01 - EP IL KR US); **C07K 5/06113** (2013.01 - EP IL KR US); **C07K 5/06165** (2013.01 - US); **C07K 5/1008** (2013.01 - EP IL KR US)

Citation (search report)
See references of WO 2022081911A1

Designated contracting state (EPC)
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Designated extension state (EPC)
BA ME

Designated validation state (EPC)
KH MA MD TN

DOCDB simple family (publication)
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